AMT1227 2 – 4GHz Low Noise Amplifier Chip

Key Features :

- Frequency range : 2 4GHz
- Typical gain : 29dB
- Input standing wave : 1.5
- Output standing wave : 1.6
- Noise figure : 0.45dB
- P-1 : 11.5dBm @ +5V/32mA
- Chip dimensions : 1.2mm x 1.2mm x 0.1mm
- Applications : wireless communication, transceiver module, radio telecommunication etc.

Description :

AMT1227 chip is a Gallium Arsenide (GaAs) high performance Low Noise Amplifier, it covers 2 – 4GHz frequency range. It uses +5V single voltage operation, noise figure is 0.45dB, and 29dB typical gain. This chip is designed with ground through metal vias on the back technology.

Absolute Maximum Ratings (Ta = 25°C)

Symbol	Parameter	Value	Remark		
Vd	Drain Voltage	+7V			
Pin	Input Signal Power	17dBm			
Tch	Operating Temperature	150°C			
Tm	Sintering Temperature	310°C	30s, N ₂ protection		
Tstg	Storage Temperature	-65 ~ +150°C			

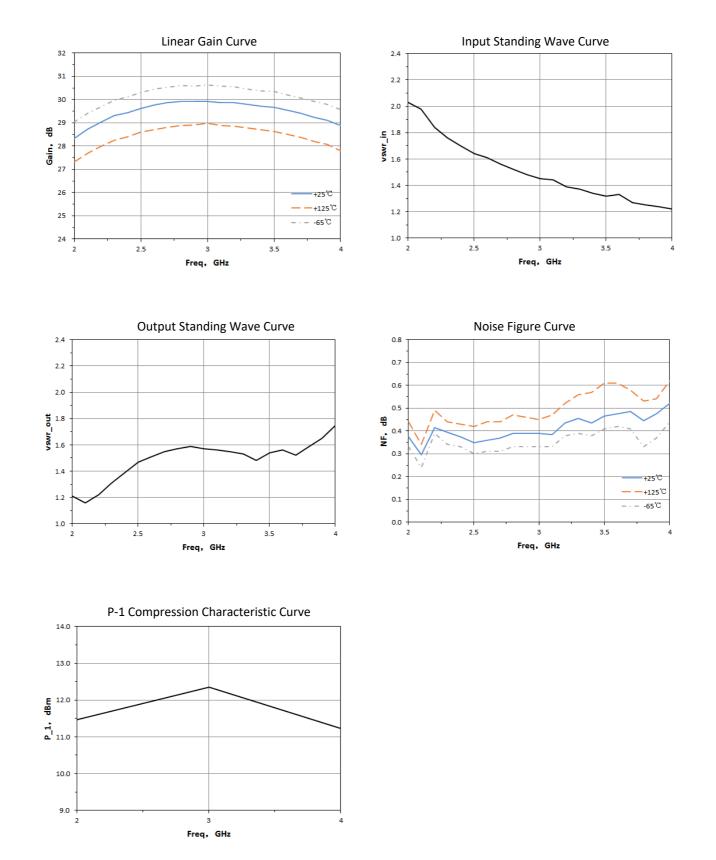
[1] Operation outside any of the Absolute Maximum Ratings may cause permanent device damage.

Electrical Characteristics (Ta = 25°C)

Symbol	Parameter	Test Conditions	Value		Unit	
			Min	Typical	Max	
G	Gain		-	29	-	dB
NF	Noise Figure		-	0.45	-	dB
Id	Static Current	Vd = +5V	-	32	-	mA
VSWR_in	Input Standing Wave	F : 2 ~ 4GHz	-	1.5	-	-
VSWR_out	Output Standing Wave		-	1.6	-	-
P-1	Output Power at 1dB point		-	11.5	-	dBm

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Typical Performance

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٧d 1200 100pF -1200 1088 V Vd **G1** P RF_out -728 RF_in RFout 638 RFin 0 Ó

Chip Dimensions (Unit : µm)

Pad Definition

Symbol	Function Description	Demensions	Equivalent Circuit
RFin	RF signal input port, connecting to external 50 Ω system, need to add DC blocking capacitor.	100µm*100µm	RF₋in ⊖⊣⊣⊢⊢⊢
RFout	RF signal output port, connecting to external 50 Ω system, need to add DC blocking capacitor.	100µm*100µm	-↓ RF_out
Vd	Amplifier bias, need to connect 100pF external capacitor	100µm*100µm	

Please see Appendix A for details.

Chip Layout Diagram